1. PCN basic data		
1.1 Company	STMicroelectronics International N.V	
1.2 PCN No.	IPD/16/9578	
1.3 Title of PCN	Comm. Products L5970D, L5972D, L5970AD, L6902D, L6932D1.2 and L6932D1.8: Implementation of Cu Wire Bonding	
1.4 Product Category	DC-DC Switching Regulator and Computing	
1.5 Issue date	2016-01-15	

2. PCN Team		
2.1 Contact supplier		
2.1.1 Name	ROBERTSON HEATHER	
2.1.2 Phone	+1 8475853058	
2.1.3 Email	heather.robertson@st.com	
2.2 Change responsibility		
2.2.1 Product Manager	Massimiliano MERISIO	
2.1.2 Marketing Manager	Maria Rosa BORGHI	
2.1.3 Quality Manager	Paolo MORETTI	

3. Change		
3.1 Category	3.2 Type of change	3.3 Manufacturing Location
Materials	New direct material part number (same supplier, different supplier or new supplier), lead frame, resin, wire, ?)	ST Shenzhen (China)

4. Description of change			
	Old	New	
4.1 Description	The above mentioned products are currently assembled in ST Shenzhen using Gold wire .	The above mentioned products will be assembled in ST Shenzhen using Copper wire.	
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	No impact.		

5. Reason / motivation for change		
5.1 Motivation	In order to rationalize and optimize manufacturing lines.	
5.2 Customer Benefit	MANUFACTURING FLEXIBILITY	

6. Marking of parts / traceability of change		
6.1 Description	By a new internal part number (Finished Goods)	

7. Timing / schedule	
7.1 Date of qualification results	2015-12-11
7.2 Intended start of delivery	2016-03-31
7.3 Qualification sample available?	Upon Request

8. Qualification / Validation			
8.1 Description	UD09 UD10 UD72 and UT20 Reliability Report.pdf		
8.2 Qualification report and qualification results	Available (see attachment)	Issue Date	2016-01-15

9. Attachments (additional documentations)

9578PpPrdtLst.pdf Change of bill of material in Shenzhen assembly site on some SO8 packaged products.pdf UD09 UD10 UD72 and UT20 Reliability Report.pdf

10. Affected parts			
10. 1 Current		10.2 New (if applicable)	
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No	
L5970AD	L5970AD		
	L5970ADTR		
L5970D	L5970D		
L5970D013TR	L5970D013TR		
L5972D	L5972D		
L5972D013TR	L5972D013TR		
L6902D	L6902D		
L6902D013TR	L6902D013TR		
L6932D1.2	L6932D1.2		
L6932D1.2TR	L6932D1.2TR		



Public Products List

PCN Title : Comm. Products L5970D, L5972D, L5970AD, L6902D, L6932D1.2 and L6932D1.8: Implementation of Cu Wire Bonding

PCN Reference : IPD/16/9578 *PCN Created on* : 11-Dec-2015

Subject : Public Products List

Dear Customer,

Please find below the Standard Public Products List impacted by the change.

L6902D013TR	L5970ADTR	L5972D
L6902D	L5972D013TR	L5970D
L6932D1.2TR	L6932D2.5	L6932D1.2
L5970D013TR	L6932D2.5TR	L6932D1.8
L5970AD	L6932D1.8TR	

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